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APPLICATION NO.	i	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.		
10/743,270	0/743,270 12/23/2003		Levinus Pieter Bakker	081468-0307112	4454		
909	7590 05/09/2006 EXAMINER						
		THROP SHAW P	NGUYEN	NGUYEN, HUNG			
P.O. BOX 10500 MCLEAN, VA 22102				ART UNIT	PAPER NUMBER		
				2851			
					DATE MAILED: 05/09/2006		

Please find below and/or attached an Office communication concerning this application or proceeding.

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	Application No.	Applicant(s)		
0.55	10/743,270	BAKKER, LEVINI	BAKKER, LEVINUS PIETER	
Office Action Summary	Examiner	Art Unit		
	Hung Henry V. Nguyen	2851	<u> </u>	
The MAILING DATE of this communication ap Period for Reply	ppears on the cover sheet	with the correspondence ac	idress	
A SHORTENED STATUTORY PERIOD FOR REPLY WHICHEVER IS LONGER, FROM THE MAILING [In Extensions of time may be available under the provisions of 37 CFR 1 after SIX (6) MONTHS from the mailing date of this communication. If NO period for reply is specified above, the maximum statutory period Failure to reply within the set or extended period for reply will, by statutory period to the provided by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b).	DATE OF THIS COMMUN. 136(a). In no event, however, may a d will apply and will expire SIX (6) MO te, cause the application to become	NICATION. a reply be timely filed  ONTHS from the mailing date of this c ABANDONED (35 U.S.C. § 133).		
Status				
1) Responsive to communication(s) filed on 12	April 2006.			
2a) This action is <b>FINAL</b> . 2b) ⊠ Th	is action is non-final.			
3) Since this application is in condition for allows	•	•	e merits is	
closed in accordance with the practice under	Ex parte Quayle, 1935 C.	D. 11, 453 O.G. 213.		
Disposition of Claims				
4)  Claim(s) 1-29 is/are pending in the application 4a) Of the above claim(s) is/are withdra 5)  Claim(s) is/are allowed.  6)  Claim(s) 1-29 is/are rejected.  7)  Claim(s) is/are objected to.  8)  Claim(s) are subject to restriction and/	awn from consideration.			
Application Papers				
9) ☐ The specification is objected to by the Examin 10) ☑ The drawing(s) filed on 23 December 2003 is/ Applicant may not request that any objection to the Replacement drawing sheet(s) including the correct 11) ☐ The oath or declaration is objected to by the Examination is objected.	are: a)⊠ accepted or b)[ e drawing(s) be held in abeya ction is required if the drawin	ance. See 37 CFR 1.85(a).  ng(s) is objected to. See 37 CF	FR 1.121(d).	
Priority under 35 U.S.C. § 119				
12) Acknowledgment is made of a claim for foreig a) All b) Some * c) None of:  1. Certified copies of the priority document 2. Certified copies of the priority document 3. Copies of the certified copies of the priority document application from the International Bureat * See the attached detailed Office action for a list	nts have been received.  Its have been received in ority documents have been au (PCT Rule 17.2(a)).	Application No in received in this National	Stage	
Attachment(s)  1) ☑ Notice of References Cited (PTO-892)	4) 🗆 Interview	v Summary (PTO-413)		
<ul> <li>Notice of Draftsperson's Patent Drawing Review (PTO-948)</li> <li>Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08 Paper No(s)/Mail Date 1/13/06.</li> </ul>	Paper No	o(s)/Mail Date f Informal Patent Application (PTC	O-152)	

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#### **DETAILED ACTION**

### Status of Prosecution

1. Applicant's arguments along with pre-appeal brief request for review filed April 12, 2006 have been carefully reviewed. As a result of the pre-appeal conference, the finality of the previous office action is withdrawn. The Examiner has changed the arts and/or advanced new arguments.

#### Claim Objections

3. Claims 28-29 are objected to because of the following informalities: Claims 28 and 29 are objected to as being improper dependent claims. The claims are drawn to a device manufactured by the apparatus or a method of claims 1 and 21 respectively. It is conceivable that the device (for example, in this case, it is the substrate/or wafer) can be made by another apparatus and/or method other than the apparatus and method of claims 1 and 21. The claims do not further limit claims 1 and 21 as required by 35 USC 112, 4<sup>th</sup> paragraph. Appropriate correction is required.

## Claim Rejections - 35 USC § 102

4. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.
- (e) the invention was described in a patent granted on an application for patent by another filed in the United States before the invention thereof by the applicant for patent, or on an international application by another who

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has fulfilled the requirements of paragraphs (1), (2), and (4) of section 371(c) of this title before the invention thereof by the applicant for patent.

The changes made to 35 U.S.C. 102(e) by the American Inventors Protection Act of 1999 (AIPA) and the Intellectual Property and High Technology Technical Amendments Act of 2002 do not apply when the reference is a U.S. patent resulting directly or indirectly from an international application filed before November 29, 2000. Therefore, the prior art date of the reference is determined under 35 U.S.C. 102(e) prior to the amendment by the AIPA (pre-AIPA 35 U.S.C. 102(e)).

5. Claims 1-7, 9-22, 24, and 26-29 are rejected under 35 U.S.C. 102(e) as being anticipated by Koster et al (U.S.Pat. 6,614,505).

With respect to claims 1, 19, 21 and 27-29, Koster et al discloses a lithographic projection apparatus and corresponding method comprising all structures set forth in the instant claims such as: a radiation system (LA) and an illumination system (IL) for supplying a beam of radiation (PB); a support structure (MT) that supports a patterning device (MA) the patterning structure configured to pattern the beam of radiation according to a desired pattern; a substrate support (WT) that supports a substrate (W); a projection system (PL) that projects the patterned beam onto a target portion of the substrate; an electrode (133; 135) and a voltage source (134; 136) that applies an electric field between the radiation source (LA) and the electrode to generate a discharge between the radiation source and the electrode (see figure 2).

As to claim 2, Koster et al disclose the electrode (133; 135) being positioned in the beam of radiation (PB).

As to claim 3, Koster et al disclose a contaminant barrier disposed downstream, relative to the direction of propagation of the beam of radiation, of the radiation source.

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generate a DC field (see col.7, lines 42-50).

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With respect to claims 4 and 24, the electrode (133; 135) is a contaminant barrier (130, 137) disposed downstream, relative to the direction of propagation of the beam of radiation, of the radiation source.

As to claims 5-6, Koster discloses that the electrode is a hollow cathode (see figure 2). With respect to claims 7, and 22, it is disclosed that the voltage source is arranged to

As to claim 9, Koster discloses a magnetic field generator is provided to apply an axial magnetic field between the radiation source (LA) and the electrode (133; 135).

With respect to claims 10 and 26, Koster disclose a gas (15) is provided in a region traversed by the beam or radiation.

As to claims 11-13, Koster discloses that the gas comprises an extreme-ultra violet transparent gas/inert gas/or noble gas and a gas supply (14) is constructed and arranged to provided the gas in the region traversed by the projection beam.

As to claim 14, Koster discloses an exhaust system (16) positioned upstream, relative to the direction of propagation of the beam of radiation, of the gas supply unit (14) to remove the gas from the region traversed by the beam of radiation, and to create a gas flow being substantially directed in an opposite direction to a direction of propagation of contaminant particles.

As to claims 15-18, Koster et al discloses the lithographic projection system comprises a laser-produced, or discharge, plasma radiation source having wavelength of about 157 nm or having a wavelength in the range of 5-20 nm (see col.5, lines 21-26).

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As to claim 25, Koster et al discloses the electric field between the radiation source and the electrode having a voltage difference up to about 1000 V (see col. 7, lines 45-50).

6. Claims 1-4, 7-8, 15-25 and 27-29 are rejected under 35 U.S.C. 102(e) as being anticipated by Moors et al (U.S.Pat. 6,781,673).

With respect to claims 1-4, 19-22, 24, 27-29, Moors et al discloses a lithographic projection apparatus, device manufacturing method and method for debris suppression, comprising all structures set forth in the instant claims such as: a radiation system (LA) and an illumination system (IL) for supplying a beam of radiation (PB); a support structure (MT) that supports a patterning device (MA) the patterning structure configured to pattern the beam of radiation according to a desired pattern; a substrate support (WT) that supports a substrate (W); a projection system (PL) that projects the patterned beam onto a target portion of the substrate; an electrode (9; 11; 12; 150) and a voltage source (see figure 2) that applies an electric field between the radiation source (LA) and the electrode to generate a discharge between the radiation source and the electrode. Moor et al further discloses the electrode (9; 11; 12; 150) being positioned in the beam of radiation (PB) and a contaminant barrier (see col.9, lines 22-30) disposed downstream, relative to the direction of propagation of the beam of radiation, of the radiation source (see figure 2; 13).

With respect to claims 7, and 22, it is disclosed that the voltage source is arranged to generate a DC field (see col.7, lines 42-50).

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As to claims 8 and 23, Moor et al disclose the voltage source being arranged to generate a square wave modulated electric field that is synchronized with the radiation source (see col.9, lines 29-30).

As to claim 9, Moors et al discloses a magnetic field generator is provided to apply an axial magnetic field between the radiation source (LA) and the electrode (see figure 2).

As to claims 15-18, Moor et al discloses the lithographic projection system comprises a laser-produced, or discharge, plasma radiation source having wavelength of about 157 nm or having a wavelength in the range of 5-20 nm (see col.5, lines 55-60).

As to claim 25, Moor et al discloses the electric field between the radiation source and the electrode having a voltage difference up to about 1000 V (see col. 8, lines 36-41).

7. Claims 19-20, and 27 are rejected under 35 U.S.C. 102(b) as being anticipated by Silfvast et al (U.S.Pat. 6,232,613).

With respect to claims 19-20 and 27, Silfvast et al discloses a radiation system and a corresponding method comprising all of the limitations of the instant claims including: a radiation source (EUV); an electrode (10, 30) and a voltage source (V) that applies an electric field between the radiation source and the electrode and generates a discharge between the radiation source and the electrode to capture contaminant particles from the radiation source.

## Claim Rejections - 35 USC § 103

8. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person

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having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

9. Claims 1-7, 15-22, 24, 27-29 are rejected under 35 U.S.C. 103(a) as being unpatentable over Ogushi et al (U.S.Pat. 6,867,843) in view of Silfvast et al (U.S.Pat. 6,232,613).

With respect to claims 1-7, 15-22, 24, 27-29, Ogushi et al discloses a lithographic projection apparatus and corresponding method comprising substantially all of the limitations of the instant claims such as: a radiation system (800) having a radiation source of a wavelength of about 13 nm (see col.5, lines 65-66); an illumination system (see figure 1) for supplying a beam of radiation; a support structure (824) for supporting a patterning device (820), the patterning device configured to pattern the beam of radiation according to a desired pattern; a substrate support (854) for supporting a substrate; a projection system (840) for projecting the pattern formed on the patterning device onto a target portion of the substrate (850) and a debris removing system (100) having an attracting surface (130) placed between the radiation source and the mirror for capturing contaminant particles from the radiation source. Osughi does not expressly disclose the attracting surface being an electrode and a voltage source applied a discharge/or an electric field between the radiation source and the electrode for capturing the particles from the radiation source. However, Ogushi suggests that a discharging type such as hollow-cathode triggered Z-pinch type and the like may be applied to the debris removing system (see col.11, lines 1-3). Furthermore, as discussed above, Silfvast et al discloses a debris blocker for used in a lithography system, the debris blocker has an electrode (10, 30) and a voltage source (V) for generating a discharge and capturing contaminant particles from a radiation source. In view of such teachings, it would have been obvious to one having ordinary skill in the art at the time the invention was made to combine the teachings of Ogushi et al and

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Silfvast et al to obtain the invention as specified in the above mentioned claims of the present invention. It would have been obvious to a skilled artisan to apply a voltage to the attracting plate (130) of Ogushi et al as suggested by Silfvast for the purpose of generating a discharge between the radiation source and the attracting plate for capturing the particle from the radiation source whereby the optical elements of the lithographic projection exposure apparatus can be prevented from being contaminated and thus improving the quality of the images.

## Response to Applicant's Arguments

10. Applicant's arguments filed 4/12/06 have been carefully reviewed but have been traversed in view of the rejections set forth above.

With respect to claims 19-20, in response to applicant's arguments that Silfvast et al does not teach an electric field between the radiation source and the electrode; the Examiner respectfully disagrees with the applicant since Silfvast clearly teaches "the present invention is to provide a trap for collecting optic harming debris that are ejected <u>from</u> an operating capillary discharge lamp" (see col.2, lines 60-63). Based on that teachings, the electric field must be generated somewhere <u>between</u> the discharge lamp and the electrode to capture the harming debris from the discharge lamp/radiation source, as claimed (in the broadest sense).

With respect to claims 28 and 29, the claims recite a device made by the apparatus and the method of claim 1 and 21, respectively. The applicant is again reminded that it is conceivable that the claimed device can be made by another apparatus/and method other than the apparatus and method of claims 1 and 21. Clearly, the device (for instance: the photosensitive substrate in this case) can made by another apparatus/method such as the apparatus/method of

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Silfvast et al. It has been held that the patentability of a device /product does not depend on its method of production. Once a product appearing to be substantially identical is found and a 35 U.S.C. 102/103 rejection made, the burden shifts to the applicant to show an unobvious difference (see *In re Mareosi*, 710 F.2d 798, 802, 218 USPQ 289, 292 (Fed. Cir. 1983).

11. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Hung Henry V. Nguyen whose telephone number is 571-272-2124. The examiner can normally be reached on Monday-Friday (First Friday off).

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Judy Nguyen can be reached on 571-272-2258. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Hung Henry V Nguyen Primary Examiner

Hranhanner.

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